UGS3059 and UGx3060

Hall Effect Gear Tooth Sensor ICs, AC Coupled

Discontinued Product

These parts are no longer in production The device should not be purchased for new design applications. Samples are no longer available.

Date of status change: October 31, 2005

Recommended Substitutions:

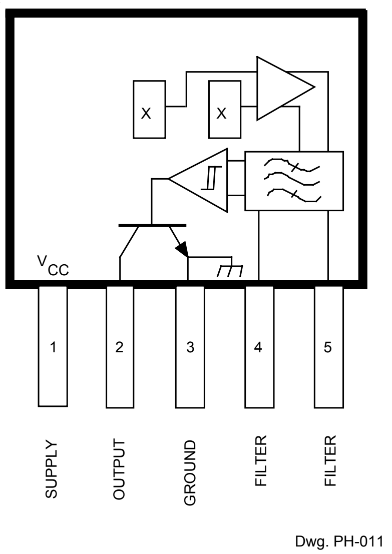
For new customers and applications:

- *For the UGS3059, refer to the A1423LK.*
- *For the UGN3060 and UGS3060, refer to the A1422LK.*

NOTE: For detailed information on purchasing options, contact your local Allegro field applications engineer or sales representative.

3059 AND 3060

HALL-EFFECT GEAR-TOOTH SENSOR ICS —AC COUPLED



Pinning is shown viewed from branded side.

ABSOLUTE MAXIMUM RATINGS at T_A = +25°C

Supply Voltage, V_{CC} .... **24 V**
Reverse Battery Voltage, V_{RCC} .... **-30 V**
Magnetic Flux Density, B .... **Unlimited**
Output OFF Voltage, V_{OUT} .... **24 V**
Output Current, I_{OUT} .... **25 mA**
Package Power Dissipation,
P_D .... **500 mW**
Operating Temperature Range, T_A
Prefix 'UGN' .... **-20°C to +85°C**
Prefix 'UGS' .... **-40°C to +125°C**
Storage Temperature Range,
T_S .... **-65°C to +150°C**

The UGS3059KA and UGN/UGS3060KA ac-coupled Hall-effect gear-tooth sensor IC s are monolithic integrated circuits that switch in response to changing differential magnetic fields created by moving ferrous targets. These devices are ideal for use in non-zero-speed, gear-tooth-based speed, position, and timing applications such as in anti-lock braking systems, transmissions, and crankshafts.

Both devices, when coupled with a back-biasing magnet, can be configured to turn ON or OFF with the leading or trailing edge of a gear-tooth or slot. Changes in fields on the magnet face caused by a moving ferrous mass affect two integrated Hall transducers and are differentially amplified by on-chip electronics. This differential design provides immunity to radial vibration within the devices' operating air gaps. Steady-state magnet and system offsets are eliminated using an on-chip differential band-pass filter. This filter also provides relative immunity to interference from RF and electromagnetic sources. The on-chip temperature compensation and Schmitt trigger circuitry minimizes shifts in effective working air gaps and switch points over temperature, allowing operation to low frequencies over a wide range of air gaps and temperatures.

Each Hall-effect digital Integrated circuit includes a voltage regulator, two quadratic Hall-effect elements, temperature compensating circuitry, a low-level amplifier, band-pass filter, Schmitt trigger, and an open-collector output driver. The on-board regulator permits operation with supply voltages of 4.5 to 24 volts. The output stage can easily switch 20 mA over the full frequency response range of the devices and is compatible with bipolar and MOS logic circuits.

The two devices provide a choice of operating temperature ranges. Both devices are packaged in a 5-pin plastic SIP, with an option of trimmed, formed pins for horizontal mounting. The UGN/UGS3060KA offers a Pb (lead) free version, with 100% matte tin leadframe plating.

FEATURES

- Used in Sensing Motion of Ferrous Targets Such as Gears
- Wide Operating Temperature Range
- Operation to 30 kHz
- Resistant to RFI, EMI
- Large Effective Air Gap
- 4.5 V to 24 V Operation
- Output Compatible With All Logic Families
- Reverse Battery Protection
- Resistant to Physical Stress

Selection Guide

<table>
<tr><th>Part Number</th><th>Pb-free</th><th>Package</th><th>Operating Range, T_A (°C)</th><th>B_{OP}, Typ. (G)</th><th>B_{RP}, Typ. (G)</th><th>Packing*</th></tr>
<tr><td>UGS3059KA</td><td>–</td><td>Vertical mount leads</td><td rowspan="2">–40 to 125</td><td rowspan="2">65</td><td rowspan="2">–65</td><td rowspan="10">Bulk, 500 pieces per bag</td></tr>
<tr><td>UGS3059KATL</td><td>–</td><td>Horizontal mount leads</td></tr>
<tr><td>UGN3060KA</td><td>–</td><td rowspan="2">Vertical mount leads</td><td rowspan="4">–20 to 85</td><td rowspan="8">15</td><td rowspan="8">–15</td></tr>
<tr><td>UGN3060KA–T</td><td>Yes</td></tr>
<tr><td>UGN3060KATL</td><td>–</td><td rowspan="2">Horizontal mount leads</td></tr>
<tr><td>UGN3060KATL–T</td><td>Yes</td></tr>
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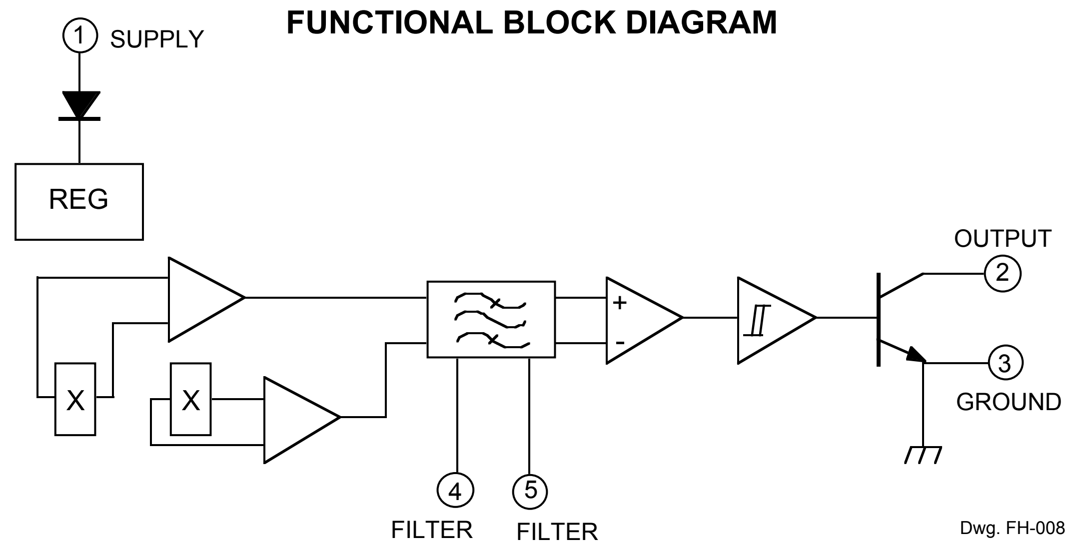
<tr><td>UGS3060KATL–T</td><td>Yes</td></tr>
</table>

*Contact Allegro for additional packing options.

Allegro® MicroSystems, Inc.
115 Northeast Cutoff, Box 15036
Worcester, Massachusetts 01615-0036 (508) 853-5000

3059 AND 3060
HALL-EFFECT GEAR-TOOTH SENSOR ICS —AC COUPLED



ELECTRICAL CHARACTERISTICS over operating temperature range.

Characteristic	Symbol	Test Conditions	Limits Min.	Typ.	Max.	Units
Supply Voltage	V_{CC}	Operating	4.5	—	24	V
Output Saturation Voltage	$V_{OUT(SAT)}$	I_{OUT} = 20 mA, B > B_{OP}	—	130	400	mV
Output Leakage Current	I_{OFF}	V_{OUT} = 24 V, B < B_{RP}	—	—	10	µA
Supply Current	I_{CC}	V_{CC} = 18 V, B < B_{RP}	—	11	20	mA
High-Frequency Cutoff	f_{coh}	-3 dB	30	—	—	kHz
Output Rise time	t_r	V_{OUT} = 12 V, R_L = 820 Ω	—	0.04	0.2	µs
Output Fall time	t_f	V_{OUT} = 12 V, R_L = 820 Ω	—	0.18	0.3	µs

MAGNETIC CHARACTERISTICS over operating temperature and supply voltage ranges

		Part Numbers						
		UGS3059KA			UGN3060KA or UGS3060KA			
Characteristic	Test Conditions	Min.	Typ.	Max.	Min.	Typ.	Max.	Units
Operate Point, B_{OP}	Output switches OFF to ON	10	65	100	5.0	15	35	G
Release Point, B_{RP}	Output switches ON to OFF	-100	-65	-10	-35	-15	-5.0	G
Hysteresis, B_{hys}	B_{OP} - B_{RP}	—	130	—	—	30	—	G

NOTES: 1. Magnetic switch points are specified as the difference in magnetic fields at the two Hall elements.
2. As used here, negative flux densities are defined as less than zero (algebraic convention).
3. Typical values are at T_A = 25°C and V_{CC} = 12 V.
4. 1 gauss (G) is exactly equal to 0.1 millitesla (mT).

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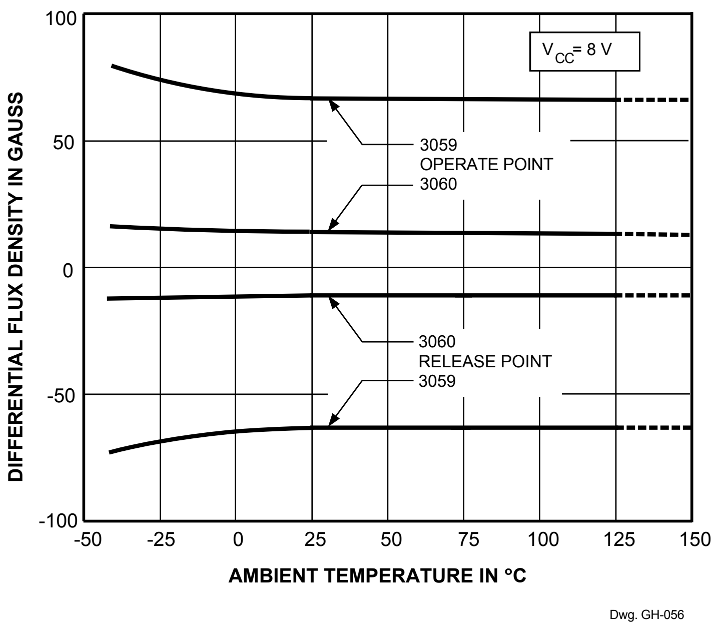
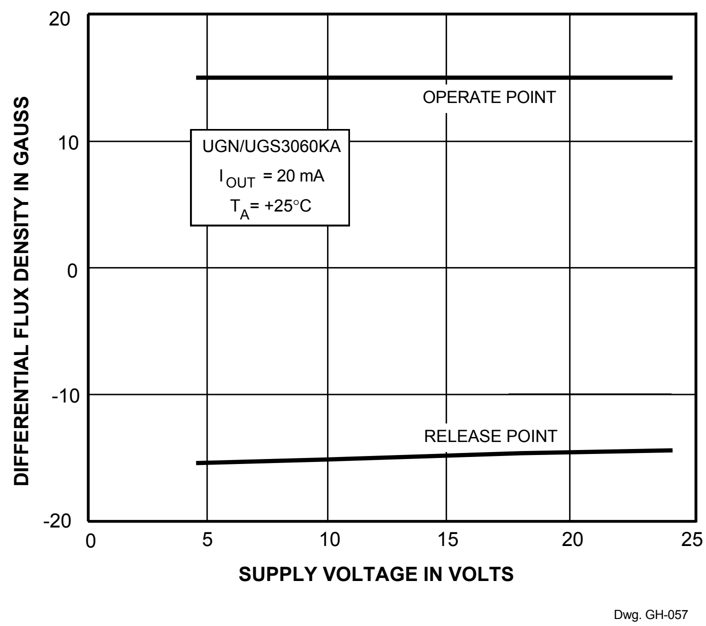
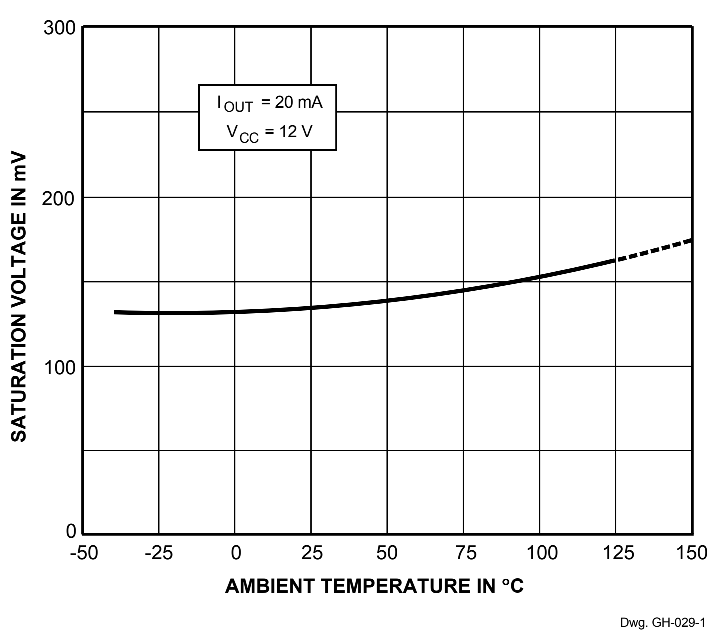
TYPICAL OPERATING CHARACTERISTICS

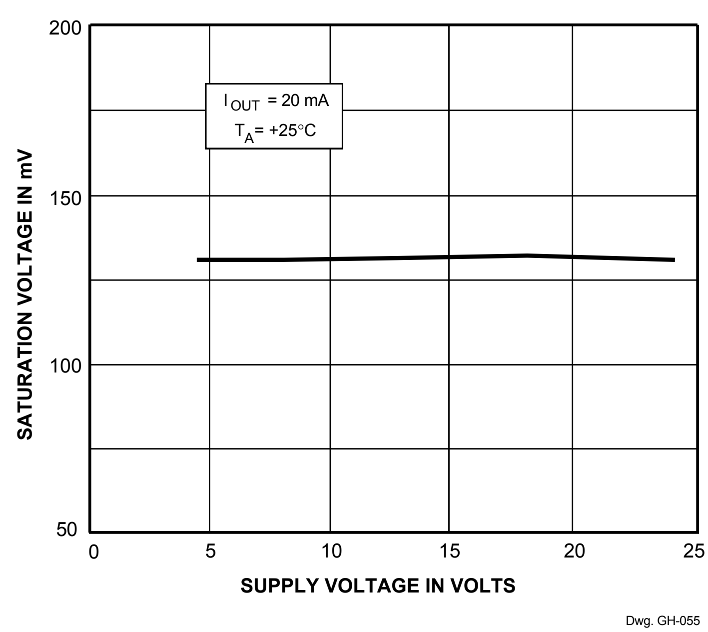
SWITCH POINTS





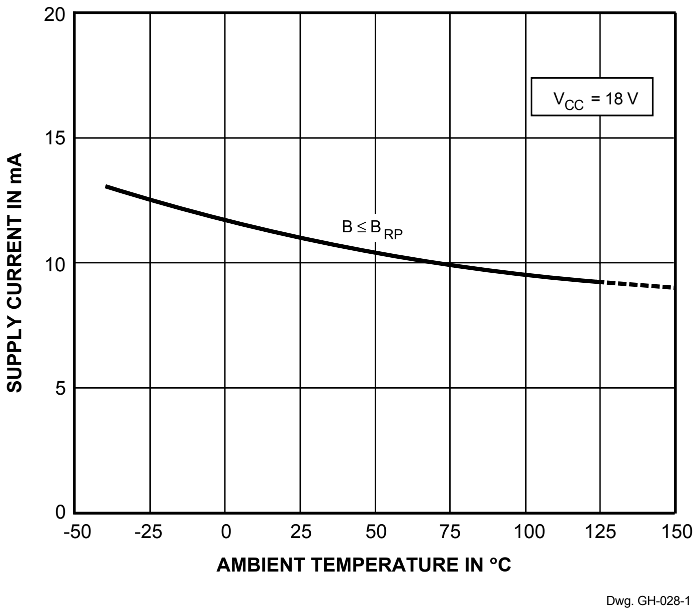
OUTPUT SATURATION VOLTAGE

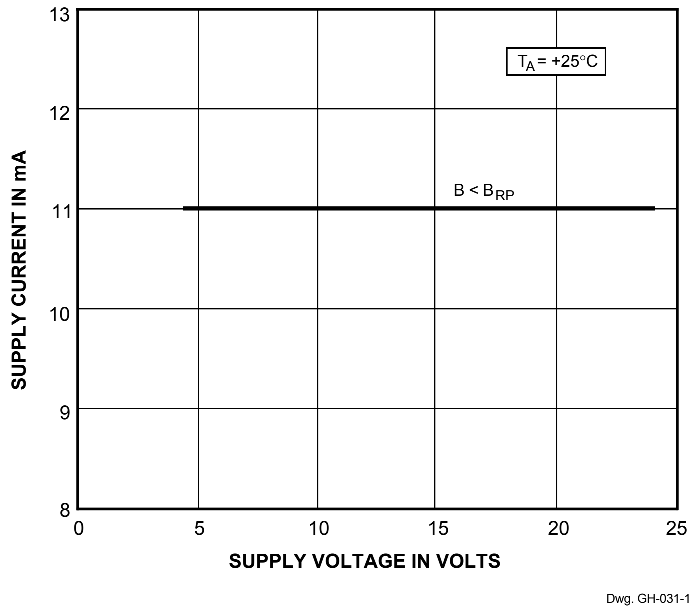




TYPICAL OPERATING CHARACTERISTICS

SUPPLY CURRENT





APPLICATIONS INFORMATION

A gear-tooth sensing system consists of the sensor IC, a back-biasing magnet, and a target. The system requirements are usually specified in terms of the effective working air gap between the package and the target (gear teeth), the number of switching events per rotation of the target, temperature and speed ranges, minimum pulse duration or duty cycle, and switch point accuracy. Careful choice of the sensor IC, magnet material and shape, target material and shape, and assembly techniques enables large working air gaps and high switch-point accuracy over the system operating temperature range.

Naming Conventions. With a south pole in front of the branded surface of the device or a north pole behind the device, the field at the element is defined as positive. As used here, negative flux densities are defined as less than zero (algebraic convention), e.g., -100 G is less than +50 G.

Magnet Biasing. In sensing moving non-magnetized ferrous targets, these devices must be back-biased by mounting the unbranded side on a small permanent magnet. Either magnetic pole (north or south) can be used.

The devices can also be used without a back-biasing magnet. In this configuration, the device can be used to detect a rotating ring magnet such as those found in brushless dc motors or in speed sensing applications. Here, the device detects the magnetic field gradient created by the magnetic poles.

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APPLICATIONS INFORMATION (cont'd)

Figure 1
TYPICAL TRANSFER CHARACTERISTIC

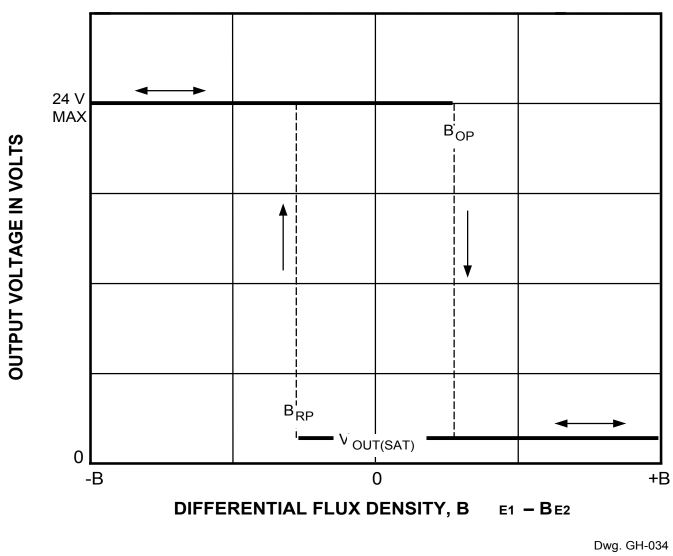
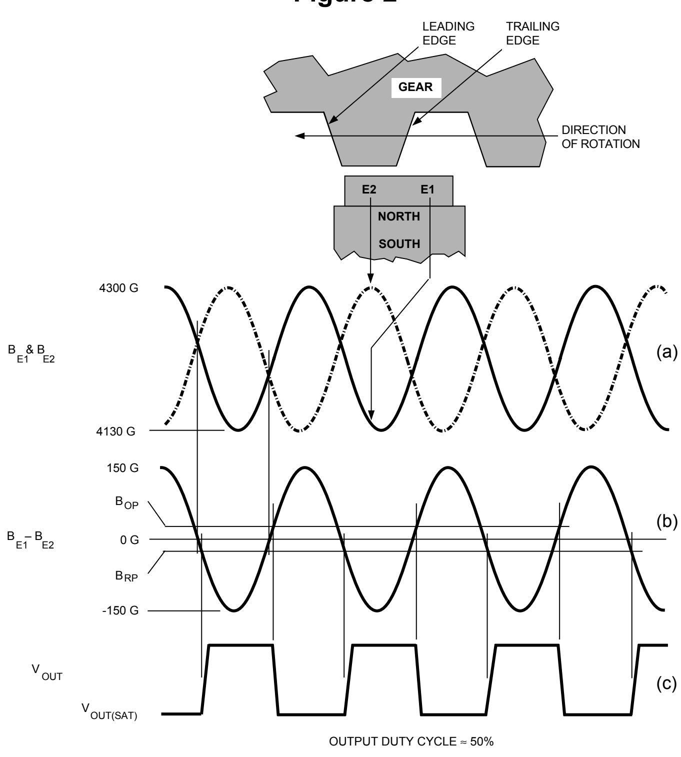


Figure 2



Device **Operation.** These sensor ICs each contain two integrated Hall transducers (E1 and E2) that are used in sensing a magnetic field differential across the face of the IC (see Element Location drawing). Referring to Figure 1, the trigger switches the output ON (output LOW) when B_{E1} - B_{E2} < B_{OP} and switches the output OFF (output HIGH) when B_{E1} - B_{E2} < B_{RP}. The difference between B_{OP} and B_{RP} is the hysteresis of the device.

Figure 2 relates the output state of a back-biased sensor IC, with switching characteristics shown in Figure 1, to the target gear profile and position. Assume a north pole back-bias configuration (equivalent to a south pole at the face of the device). The motion of the gear produces a phase-shifted field at E1 and E2 (Figure 2(a)); internal conditioning circuitry subtracts the fields at the two elements (Figure 2(b)); this differential field is band-pass filtered to remove dc offset components and then fed into a Schmitt trigger; the Schmitt trigger switches the output transistor at the thresholds B_{OP} and B_{RP}. As shown (Figure 2(c)), the IC output is LOW whenever element E1 sees a (ferrous) gear tooth and E2 faces air. The output is HIGH when E1 sees air and element E2 sees the ferrous target.

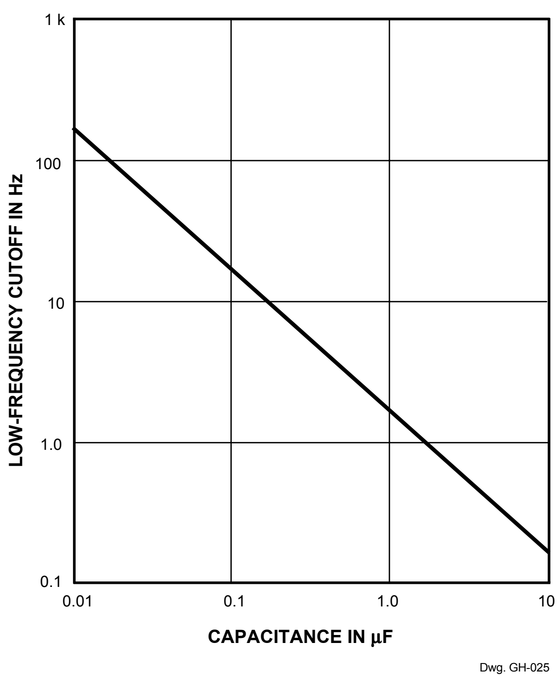
AC-Coupled Operation. Steady-state magnet and system offsets are eliminated using an on-chip differential band-pass filter. The lower frequency cut-off of this patented filter is set using an external capacitor the value of which can range from 0.01 µF to 10 µF. The high-frequency cut-off of this filter is set at 30 kHz by an internal integrated capacitor.

The differential structure of this filter enables the IC to reject single-ended noise on the ground or supply line and, hence, makes it resistant to radio-frequency and electromagnetic interference typically seen in hostile remote sensing environments. This filter configuration also increases system tolerance to capacitor degradation at high temperatures, allowing the use of an inexpensive external ceramic capacitor.

APPLICATIONS INFORMATION (cont'd)

Low-Frequency Operation. Low-frequency operation of the device is set by the value of an external capacitor. Figure 3 provides the low-frequency cut-off (-3 dB point) of the filter as a function of capacitance value. This information should be used with care. The graph assumes a perfect sinusoidal magnetic signal input. In reality, when used with gear teeth, the teeth create transitions in the magnetic field that have a much higher frequency content than the basic rotational speed of the target. This allows the device to sense speeds much lower than those indicated by the graph for a given capacitor value.

Figure 3



Capacitor Characteristics. The major requirement for the external capacitor is its ability to operate in a bipolar (non-polarized) mode. Another important requirement is the low leakage current of the capacitor (equivalent parallel resistance should be greater than 500kΩ). To maintain proper operation with frequency, capacitor values should be held to within ±30% over the operating temperature range. Available non polarized capacitors include ceramic, polyester, and some tantalum types. For low-cost operation, ceramic capacitors with temperature codes Z5S, Y5S, X5S, or X7S (depending on operating temperature range) or better are recommended. The commonly available Z5U temperature code should not be used in this application.

Magnet Selection. The UGS3059KA or UGx3060KA can be used with a wide variety of commercially available permanent magnets. The selection of the magnet depends on the operational and environmental requirements of the sensing system. For systems that require high accuracy and large working air gaps or an extended temperature range, the usual magnet material of choice is rare-earth samarium cobalt (SmCo). This magnet material has a high energy product and can operate over an extended temperature range. For systems that require low-cost solutions for an extended temperature range, AlNiCo 8 can be used. Due to its relatively low energy product, smaller operational air gaps can be expected. Neodymium iron boron (NeFeB) can be used over moderate temperature ranges when large working air gaps are required. Of these three magnet materials, AlNiCo 8 is the least expensive by volume and SmCo is the most expensive.

System Issues. Optimal performance of a gear-tooth sensing system strongly depends on four factors: the IC magnetic parameters, the magnet, the pole piece configuration, and the target.

Device Specifications. Shown in Figure 4 are graphs of the differential field as a function of air gap. A 48-tooth, 2.5" (63.5 mm) diameter, uniform target similar to that used in ABS applications is used. The samarium cobalt magnet is 0.32" diameter by 0.20" long (8.13 x 5.08 mm). The maximum functioning air gap with this typical gear/magnet combination can be determined using the graphs and specifications for the sensor IC.

In this case, if a UGx3060KA with a typical B_{OP} of 15 G and a B_{RP} of -15 G is used, the maximum allowable air gap would be approximately 0.120". If the worst case switch points of ±35 G for the UGx3060KA are used, the maximum air gap is approximately 0.105".

All system issues should be translated back to such a profile to aid the prediction of system performance.

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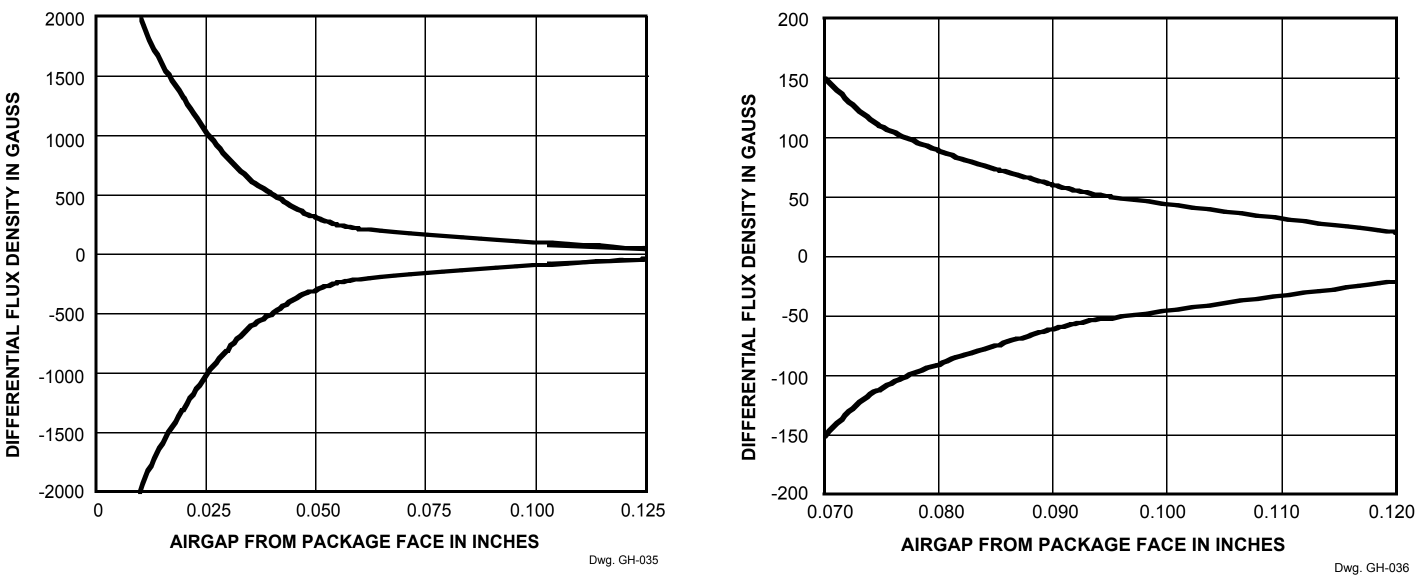
APPLICATIONS INFORMATION (cont'd)

Figure 4
DIFFERENTIAL FLUX DENSITY

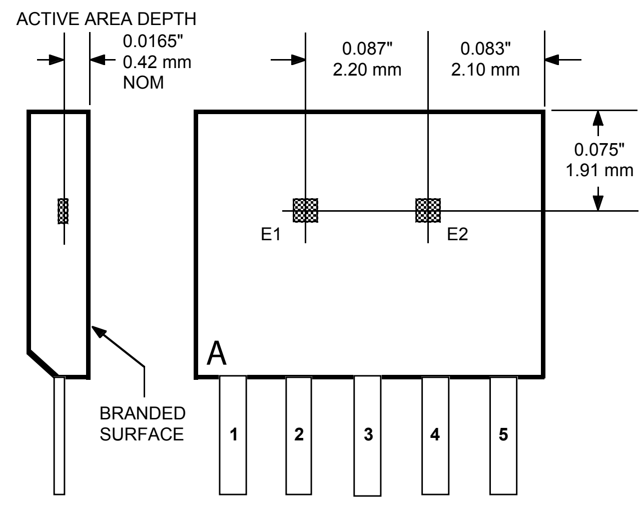


Ferrous Targets. The best ferrous targets are made of cold-rolled low-carbon steel. Sintered-metal targets are also usable, but care must be taken to ensure uniform material composition and density.

The teeth or slots of the target should be cut with a slight angle so as to minimize the abruptness of transition from metal to air as the target passes by the device. Sharp transitions will result in magnetic overshoots that can result in false triggering.

Gear teeth larger than 0.10" (2.54 mm) wide and at least 0.10" (2.54 mm) deep provide reasonable working air gaps and adequate change in magnetic field for reliable switching. Generally, larger teeth and slots allow a larger air gap. A gear tooth width approximating the spacing between elements (0.088 " or 2.24 mm) requires special care in the sytem design and assembly techniques.

Figure 5
ELEMENT LOCATIONS
(±0.005" [0.13 mm] die placement)



APPLICATIONS INFORMATION (cont'd)

Extensive applications information for Hall-effect devices is available in:

- *Hall-Effect IC Applications Guide*, Application Note 27701;
- *Hall-Effect Devices: Soldering, Gluing, Potting, Encapsulating, and Lead Forming*, Application Note 27703.1;
- *Soldering of Through-Hole Hall-Sensor Dervices*, Application Note 27703; and
- *Soldering of Surface-Mount Hall-Sensor Devices*, Application Note 27703.2.

All are provided in *Allegro Electronic Data Book*, AMS-702. or at

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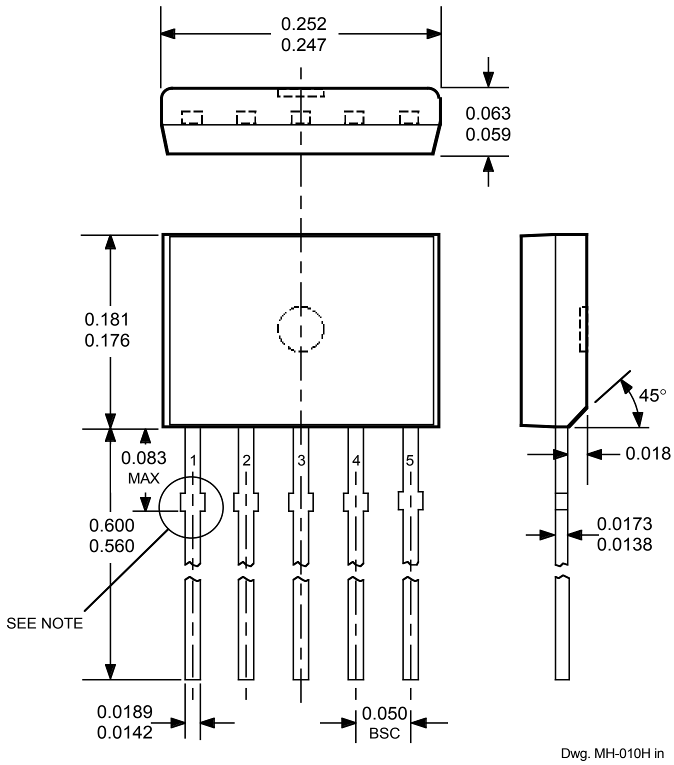
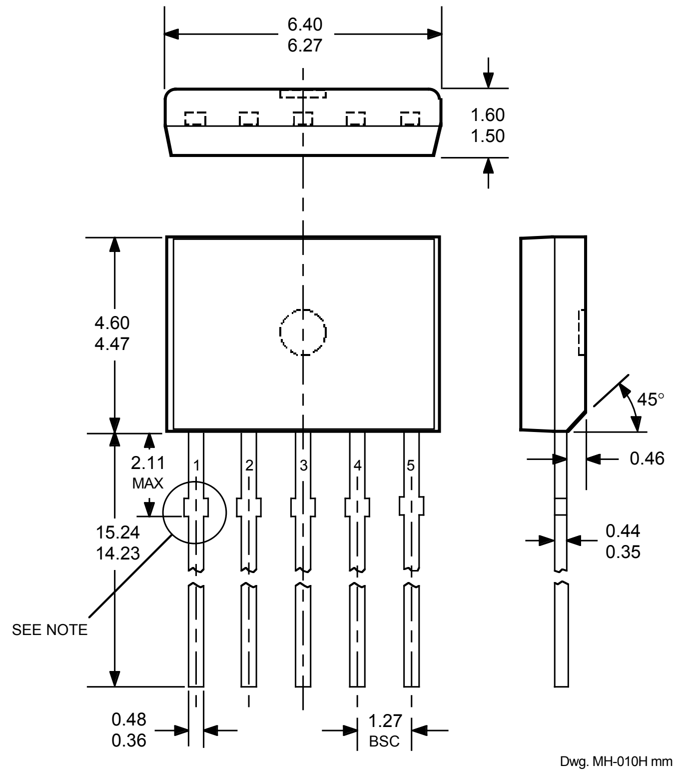
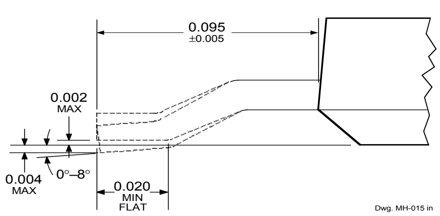
Dimensions in Inches
(controlling dimensions)

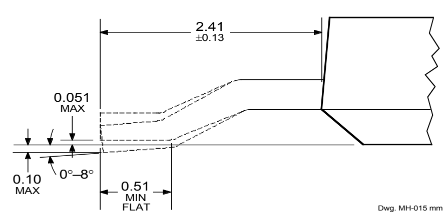


Dimensions in Millimeters
(for reference only)



Horizontal-Mount Lead Form (Suffix -TL)





NOTES:
1. Tolerances on package height and width represent allowable mold offsets. Dimensions given are measured at the widest point (parting line).
2. Exact body and lead configuration at vendor's option within limits shown.
3. Height does not include mold gate flash.
4. Recommended minimum PWB hole diameter to clear transition area is 0.035” (0.89 mm).
5. Where no tolerance is specified, dimension is nominal.
6. Supplied in bulk pack (500 pieces per bag).